## HB-2232 Reed Switch with High Breakdown Form A, Center Contact, Breakdown Voltage Configurable



This reed switch is designed with highly flexible blades to get maximum contact gap at lower AT ranges, and consequently having high break down characteristics. The two types of contacts options available provide breakdown at 350 V or 500 V minimum. Higher ampere turn groups will have even higher breakdown voltage values. This reed switch is Lead (Pb) free and RoHS compliant.

## 6 Formations Available



## A Applications

This reed switch is suitable for use in the following applications and many others: relays in food processors, power switches in explosive areas, magnetic extensometers...

䟭 Electrical

| Sub code |  | $\mathbf{L}$ | $\mathbf{H}$ |
| :--- | :---: | :---: | :---: |
| Operate Range | AT | $20-60$ | $30-60$ |
| Release Range | AT | $8-25$ | $12-25$ |
| Contact Rating (max) | $\mathrm{W} / \mathrm{VA}$ | 30.0 | 90.0 |
| Switching Current (max) | A | 0.5 | 0.75 |
| Carry Current (max) | A | 1.75 | 2.50 |
| Switching Voltage (max) | $\mathrm{V}_{\mathrm{DC}}$ | 230 | 230 |
| Switching Voltage (max) | $\mathrm{V}_{\mathrm{AC}}$ | 125 | 125 |
| Breakdown Voltage | $\mathrm{V}_{\mathrm{DC}}$ | 350 | 500 |
| Initial Contact Resistance (max) | $\mathrm{m} \Omega$ | 100 | 100 |
| Insulation Resistance (min) | $\Omega$ | $10^{11}$ | $10^{11}$ |
| Capacitance (min) | pF | 0.2 | 0.2 |

㤟 Miscellaneous

| Operate Time (max) | ms | 1.0 |
| :--- | :---: | :---: |
| Bounce Time (max) | ms | 0.5 |
| Release Time (max) | ms | 0.2 |
| Resonance Frequency | Hz | $>2000$ |
| Operating Frequency | Hz | 500 |
| Operating Temperature | ${ }^{\circ} \mathrm{C}$ | -40 to +200 |
| Test Coil |  | 717102002 |
| Lead out plating |  | $\mathrm{Sn}(\mathrm{Pb}$ free) |
| Shock Resistance | g | 50 |
| Vibration $(10-2000 \mathrm{~Hz})$ | g | 20 |


HB-2232-(Sub Code)-(Start Operate AT)(Finish Operate AT)

## Example HB-2232-H-30-35

Denotes 500 V breakdown voltage in 30-35 Operate AT band

## $\%$ Other Configurations Available

Dynamic contact resistance limit, Higher insulation resistance, Special release limits, Gold plates leads

